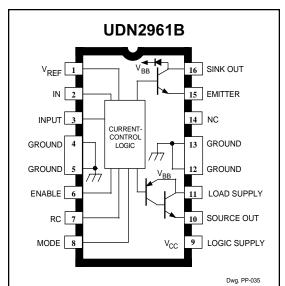
# 2961

# HIGH-CURRENT HALF-BRIDGE PRINTHEAD/MOTOR DRIVER—WITH INTERNAL CURRENT SENSING AND CONTROL



#### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, V <sub>BB</sub> 45 V
Output Current, I <sub>OUT</sub> (continuous) . ±3.4 A
$(t_W \le 20 \mu s, 10\% \text{ duty cycle}) \pm 4.0 \text{ A}$
Logic Supply Voltage, V <sub>CC</sub> 7.0 V
Input Voltage Range,
V <sub>IN</sub> 0.3 V to +7.0 V
Package Power Dissipation,
P <sub>D</sub> See Graph
Operating Temperature Range,

 $T_A$ .......................-20°C to +85°C Junction Temperature,  $T_J$ ...........+150°C\* Storage Temperature Range,

T<sub>S</sub>...... -55°C to +150°C

Output current rating may be restricted to a value determined by system concerns and factors. These include: system duty cycle and timing, ambient temperature, and use of any heatsinking and/or forced cooling. For reliable operation, the specified maximum junction temperature should not be exceeded.

\* Fault conditions that produce excessive junction temperature will activate device thermal shutdown circuitry. These conditions can be tolerated, but should be avoided.

The UDN2961B and UDN2961W are 3.4 A half bridges designed specifically for driving solenoid printheads, stepper motors, and dc motors. The UDN2961B/W consists of a power source driver output, a power sink driver output, a flyback recovery diode, internal current sensing circuitry, and a user-selectable fixed off-time chopper circuit.

The output drivers are capable of sustaining 45 V with continuous currents of  $\pm 3.4$  A and peak transient currents of  $\pm 4$  A permitted. The outputs have been optimized for a low output saturation voltage (typically 2.6 V total source plus sink drops at 3.4 A).

For output current control, load current is sensed internally and limited by chopping the output driver(s) in a user-selectable fixed off-time PWM mode. The maximum output current is determined by the user's selection of a reference voltage. The MODE pin determines whether the current control circuitry will chop in a slow current-decay mode (only the source driver switching) or in a fast current-decay mode (source and sink switching). A user-selectable blanking window prevents false triggering of the current control circuitry during chopping.

The UDN2961B is supplied in a 16-pin dual in-line plastic batwing package with a copper lead-frame and heat sinkable tabs for improved power dissipation capabilities. For higher power dissipation requirements, the UDN2961W is supplied in a 12-pin single in-line power tab package.

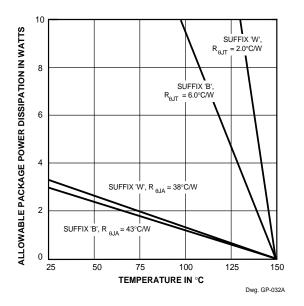
### **FEATURES**

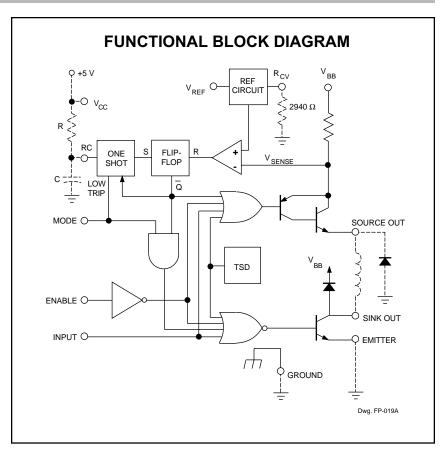
- 3.4 A, 45 V Source and Sink Drivers
- Internal Current Sensing
- User-Selectable Fixed Off-Time PWM Current Control
- Internal Flyback Diode
- Low Output Saturation Voltage
- Chip Enable
- Fast or Slow Current-Decay Modes
- Programmable Blanking Window
- Internal Thermal Shutdown Circuitry

Always order by complete part number:

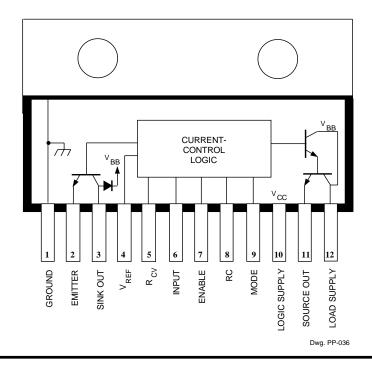
Part Number	Package
UDN2961B	16-Pin DIP
UDN2961W	12-Pin Power-Tab SIP







## **UDN2961W**





# ELECTRICAL CHARACTERISTICS at T<sub>A</sub> = +25°C, V<sub>BB</sub> = 45 V, V<sub>CC</sub> = 4.75 V to 5.25 V, R<sub>CV</sub> = 2940 $\Omega$ (unless otherwise noted).

	Symbol			Lim	its	
Characteristic		Test Conditions	Min.	Тур.	Max.	Units
Output Drivers	•		•			
Output Leakage Current	I <sub>CEX</sub>	V <sub>EN</sub> = 0.8 V, V <sub>SOURCE</sub> = 0 V	_	<-1.0	-100	μА
		V <sub>EN</sub> = 0.8 V, V <sub>SINK</sub> = 45 V	_	<1.0	100	μΑ
Output Saturation Voltage	V <sub>CE(SAT)</sub>	Source Driver, I <sub>OUT</sub> = -3.4 A	<u> </u>	1.6	2.2	V
		Source Driver, I <sub>OUT</sub> = -3.0 A	_	1.5	_	V
		Sink Driver, I <sub>OUT</sub> = 3.4 A	_	1.0	1.4	V
		Sink Driver, I <sub>OUT</sub> = 3.0 A	<u> </u>	0.9	_	V
Output Sustaining Voltage	V <sub>CE(sus)</sub>	I <sub>OUT</sub> = ±3.4 A, L = 3 mH	45	_	_	V
Recovery Diode Leakage Current	I <sub>R</sub>	V <sub>R</sub> = 45 V	_	<1.0	100	μΑ
Recovery Diode Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 3.4 A	_	_	2.0	V
Motor Supply Current	I <sub>BB(on)</sub>	V <sub>EN</sub> = 2.0 V, V <sub>IN</sub> = 0.8 V, No Load	_	_	70	mA
	I <sub>BB(off)</sub>	V <sub>EN</sub> = 0.8 V	<b> </b>	_	2.5	mA
Output Rise Time	t <sub>r</sub>	Source Driver, I <sub>OUT</sub> = -3.4 A	_	_	600	ns
		Sink Driver, I <sub>OUT</sub> = 3.4 A	<u> </u>	_	600	ns
Output Fall Time	t <sub>f</sub>	Source Driver, I <sub>OUT</sub> = -3.4 A	_	_	600	ns
		Sink Driver, I <sub>OUT</sub> = 3.4 A	<u> </u>	_	600	ns
Control Logic			-			
Logic Input Voltage	V <sub>IN(1)</sub>		2.0	_	_	V
	V <sub>IN(0)</sub>		_	_	0.8	V
Logic Input Current	I <sub>IN(1)</sub>	V <sub>IN</sub> = 5.0 V	<u> </u>	_	10	μΑ
	I <sub>IN(0)</sub>	V <sub>IN</sub> = 0 V	_	_	-1.0	mA
Reference Input Current	I <sub>REF</sub>	V <sub>REF</sub> = 5.0 V	<u> </u>	_	50	μΑ
Transconductance	I <sub>TRIP</sub> /V <sub>REF</sub>	V <sub>REF</sub> = 1.0 V	0.9	1.0	1.1	A/V
		V <sub>REF</sub> = 3.2 V	0.9	1.0	1.1	A/V
Logic Supply Current	I <sub>CC</sub>	$V_{EN} = 2.0 \text{ V}, V_{IN} = 0.8 \text{ V}, \text{ No Load}$	<u> </u>	_	160	mA
		V <sub>EN</sub> = 0.8 V	<u> </u>	_	15	mA
Turn On Delay	t <sub>pd(on)</sub>	Source Driver	-	_	600	ns
		Sink Driver	_		600	ns
Turn Off Delay	t <sub>pd(off)</sub>	Source Driver	_	_	2.0	μs
		Sink Driver			2.0	μs
Thermal Shutdown Temperature	TJ		_	165	_	°C
Negative current is defined as coming ou	t of (sourcing) the	specified device terminal.				

## APPLICATIONS INFORMATION

The UDN2961B/W is a high current half-bridge designed to drive a number of inductive loads such as printer solenoids, stepper motors, and dc motors. Load current is sensed internally and is controlled by pulse-width modulating (PWM) the output driver(s) in a fixed off-time, variable-frequency format. The peak current level is set by the user's selection of a reference voltage. A slow current-decay mode (chopping only the source driver) or a fast current-decay mode (chopping both the source and sink drivers) can be selected via the MODE pin.

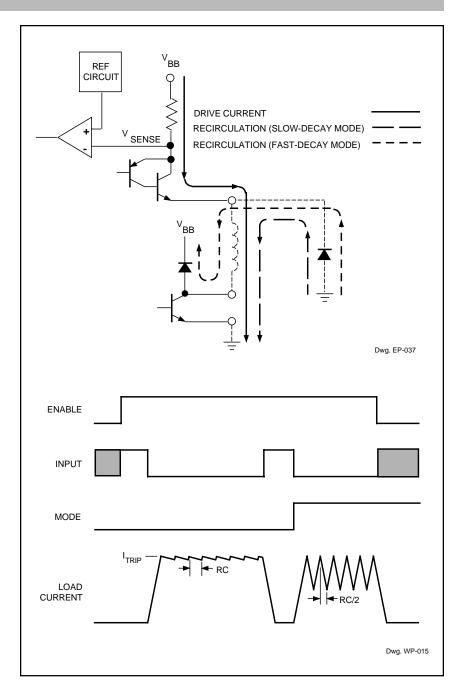
### **PWM CURRENT CONTROL**

A logic low on the MODE pin sets the current-control circuitry into the slow-decay mode. The RS flip-flop is set initially, and both the source driver and the sink driver are turned ON when the INPUT pin is at a logic low. As current in the load increases, it is sensed by the internal sense resistor until the sense voltage equals the trip voltage of the comparator. At this time, the flip-flop is reset and the source driver is turned OFF. Over the range of  $V_{\rm REF} = 0.8 \ V$  to 3.4 V, the output current trip point transfer function is a direct linear function of the reference voltage:

$$I_{TRIP} = V_{REF}$$

To ensure an accurate chop current level ( $\pm 10\%$ ), an external 2940  $\Omega \pm 1\%$  resistor ( $R_{CV}$ ) is used. The actual load current peak will be slightly higher than the trip point (especially for low-inductance loads) because of the internal logic and switching delays (typically 1.5  $\mu$ s). After the source driver turns OFF, the load current decays, circulating through an external ground clamp diode, the load, and the sink transistor. The source driver's OFF time (and therefore the magnitude of the current decrease) is determined by the one-shot's external RC timing components:

$$t_{OFF} = RC$$



within the range of 20 k $\Omega$  to 100 k $\Omega$  and 100 pF to 1000 pF. When the one-shot times out, the flip-flop is set again, the source driver is reenabled, and the load current again is allowed to rise to the set peak value and trip the comparator. This cycle repeats itself, maintaining the average load current at the desired level.



A logic high on the MODE pin sets the current-control circuitry into the fast-decay mode. When the peak current threshold is detected, the flip-flop is reset and both the source driver and the sink driver turn OFF. Load current decays quickly through the external ground clamp diode, the load, and the internal flyback diode. In the fast-decay mode, the OFF time period is one-half the time that is set by the external RC network for the slow-decay mode:

$$t_{OFF} = \frac{RC}{2}$$

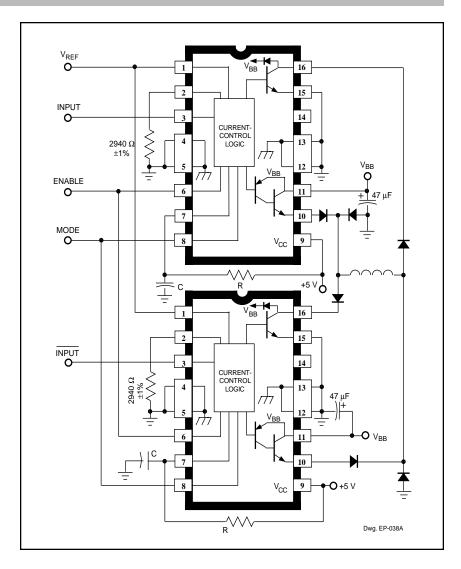
The amount of ripple current, when chopping in the fast-decay mode, is considerably higher than when chopping in the slow-decay mode.

The frequency of the PWM current control is determined by the time required for the load current to reach the set peak threshold (a function of the load characteristics and  $V_{BB}$ ) plus the OFF time of the switching driver(s) (set by the external RC components).

To prevent false resetting of the flip-flop, due to switching transients and noise, a blanking time for the comparator can be set by the user where  $t_B \approx 3600~x$  C in the slow-decay mode or  $t_B \approx 2400~x$  C in the fast-decay mode. For C between 100 pF and 1000 pF,  $t_B$  is in  $\mu s$ .

### **POWER CONSIDERATIONS**

The UDN2961B/W outputs are optimized for low power dissipation. The sink driver has a maximum saturation voltage drop of only 1.4 V at 3.4 A, while the source driver has a 2.2 V drop at -3.4 A. Device power dissipation is minimized in the slow-decay mode, as the chopping driver (the source driver) is ON for less than 50% of the chop period. When the source driver is OFF during a chop cycle, power is dissipated on chip only by the sink driver; the rest of the power is dissipated through the external ground clamp diode. In the fast-decay mode, the ON time of the chopping drivers (both the source driver



and the sink driver) may be greater than 50%, and the power dissipation will be greater.

#### **GENERAL**

A logic low on the ENABLE pin prevents the source driver and the sink driver from turning ON, regardless of the state of the INPUT pin or the supply voltages. With the ENABLE pin high, a logic low on the INPUT pin turns ON the output drivers.

To protect against inductive load voltage transients, an external ground clamp diode is required. A fast-recovery diode is recommended to reduce power dissipation in the UDN2961B/W. The blanking time prevents false triggering of the current sense comparator, which can be caused by the recovery current spike of the ground clamp diode when the chopping source driver turns ON.

The load supply  $(V_{BB})$  should be well decoupled with a capacitor placed as close as possible to the device.

The EMITTER pin should be connected to a high-current power ground.

Thermal shutdown protection circuitry is activated and turns OFF both output drivers at a junction temperature of typically +165°C. It is intended only to protect the device from catastrophic failures due to excessive junction temperatures and should not imply that output short circuits are permitted. The output drivers are re-enabled when the junction temperature cools down to approximately +145°C.

#### MOTOR DRIVER APPLICATIONS

Two UDN2961B/Ws can be cross connected as shown to form a full-bridge driver circuit. Two full-bridge circuits are needed to drive a two-phase bipolar stepper motor. When in a full-bridge configuration, one INPUT signal must be logically inverted from the other INPUT signal to prevent the simultaneous conduction of a source driver from one half-bridge and the sink driver from the other half-bridge. In order to prevent crossover currents, a turn-ON delay time of 3  $\mu s$  is needed between the time an INPUT signal for one of the half bridges goes high and the INPUT signal for the other half bridge goes low.

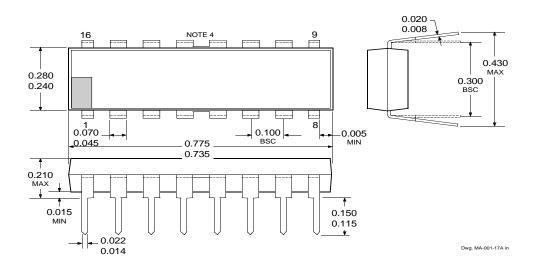
In addition to the two external ground clamp diodes, diodes in series with the load to the SINK OUT are needed in a full-bridge configuration. These series diodes prevent the sink drivers from conducting on the inverse mode, which can occur when the opposite half-bridge ground clamp diode is conducting and forces the sink driver collector below ground.

If fast current decay is used (MODE = logic high) or pulse width modulation of the load-current direction is used, diodes in series with the load to the SOURCE OUT are needed. These series diodes prevent the SOURCE OUT from inverse conducting during the recirculation period and thereby prevent shoot-through currents from occuring as the drivers turn back ON.

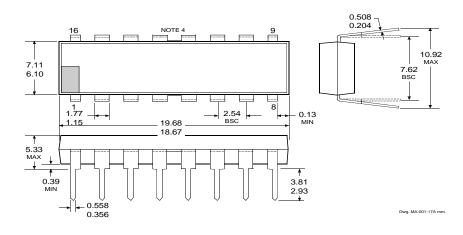


## **UDN2961B**

Dimensions in Inches (controlling dimensions)



Dimensions in Millimeters (for reference only)

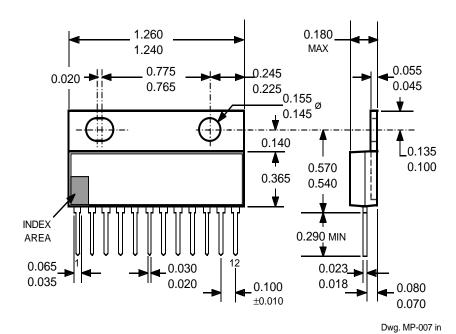


NOTES: 1. Exact body and lead configuration at vendor's option within limits shown.

- 2. Lead spacing tolerance is non-cumulative
- 3. Lead thickness is measured at seating plane or below.
- 4. Webbed lead frame. Leads 4, 5, 12, and 13 are internally one piece.

## **UDN2961W**

Dimensions in Inches (controlling dimensions)



NOTES: 1. Lead thickness is measured at seating plane or below.

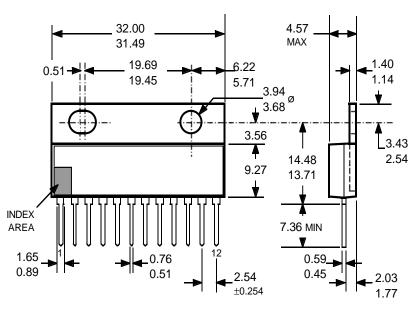
2. Lead spacing tolerance is non-cumulative

3. Exact body and lead configuration at vendor's option within limits shown.4. Lead gauge plane is 0.030" below seating plane.



## **UDN2961W**

**Dimensions in Millimeters** (for reference only)



Dwg. MP-007 mm

NOTES: 1. Lead thickness is measured at seating plane or below. 2. Lead spacing tolerance is non-cumulative

- Exact body and lead configuration at vendor's option within limits shown.
   Lead gauge plane is 0.762 mm below seating plane.

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